

General Description

The 15N50B have been fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications.

Features

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- RoHS Compliant

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	500	V
V_{GS}	Gate-Source Voltage	± 30	V
$I_D@T_C=25^\circ C$	Continuous Drain Current	15	A
$I_D@T_C=100^\circ C$	Continuous Drain Current	9.5	A
I_{DM}	Pulsed Drain Current ¹	45	A
EAS	Single Pulse Avalanche Energy ²	325	mJ
$P_D@T_C=25^\circ C$	Total Power Dissipation	90	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	62.5	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-case	1.4	$^\circ C/W$

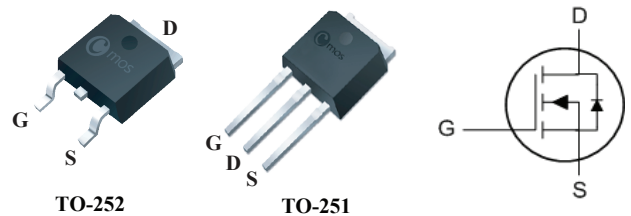
Product Summary

BVDSS	RDSON	ID
500V	0.375 Ω	15A

Applications

- DC-DC Converters
- Power switching application

TO-252/251 Pin Configuration



Type	Package	Marking
CMD15N50B	TO-252	CMD15N50B
CMU15N50B	TO-251	CMU15N50B

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=250\mu A$	500	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V$, $I_D=7.5A$	---	---	0.375	Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250\mu A$	2	---	4	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=500V$, $V_{GS}=0V$	---	---	1	μA
		$V_{DS}=400V$, $V_{GS}=0V$, $T_J=125^\circ\text{C}$	---	---	10	
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 30V$, $V_{DS}=0V$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=10V$, $I_D=1.6A$	---	8	---	S
Q_g	Total Gate Charge	$I_D=15A$ $V_{DS}=250V$ $V_{GS}=10V$ (Note 3, 4)	---	48	---	nC
Q_{gs}	Gate-Source Charge		---	12	---	
Q_{gd}	Gate-Drain Charge		---	20	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=250V$ $I_D=15A$ $R_G=6.1\Omega$ $V_{GS}=10V$ (Note 3, 4)	---	12	---	ns
T_r	Rise Time		---	30	---	
$T_{d(off)}$	Turn-Off Delay Time		---	50	---	
T_f	Fall Time		---	40	---	
C_{iss}	Input Capacitance	$V_{DS}=25V$, $V_{GS}=0V$, $f=1\text{MHz}$	---	1300	---	pF
C_{oss}	Output Capacitance		---	240	---	
C_{rss}	Reverse Transfer Capacitance		---	25	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	$V_G=V_D=0V$, Force Current	---	---	15	A
I_{SM}	Pulsed Source Current		---	---	45	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V$, $I_S=15A$, $T_J=25^\circ\text{C}$	---	---	1.2	V

Note :

- 1.Repetitive Rating: Pulse width limited by maximum junction temperature
- 2.L =10mH , $I_{AS}=8A$, $V_{DD}=100V$, Starting $T_J=25^\circ\text{C}$
- 3.Pulse Test: Pulse width $\leq 300\mu s$, Duty Cycle $\leq 2\%$
- 4.Essentially Independent of Operating Temperature Typical Characteristics

This product has been designed and qualified for the consumer market.
Cmos assumes no liability for customers' product design or applications.
Cmos reserves the right to improve product design ,functions and reliability without notice.